

Title (en)  
PROCESS FOR DEPOSITING AN ADHERENT METAL LAYER ON TITANIUM OR ITS ALLOYS

Publication  
**EP 0341546 A3 19900516 (DE)**

Application  
**EP 89107902 A 19890502**

Priority  
DE 3816495 A 19880510

Abstract (en)  
[origin: EP0341546A2] The invention relates to a process for depositing an adherent metal layer on titanium or its alloys by electroless deposition of a nickel-phosphorus alloy followed by heat treatment to form nickel-titanium diffusion layers, characterised in that the nickel layer then still present is coated with an adherent metal layer.

IPC 1-7  
**C25D 5/38; C23C 18/36**

IPC 8 full level  
**C23C 10/28** (2006.01); **C23C 18/36** (2006.01); **C23C 28/02** (2006.01); **C25D 5/38** (2006.01)

CPC (source: EP)  
**C23C 18/36** (2013.01); **C25D 5/38** (2013.01)

Citation (search report)

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